

Antenna YC0011AA Datasheet

Antenna Services

Version: 1.3

OC (Antenna Only): YC0011AA

OC (Antenna + EVB): YC0011AAEVB

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About the Document

Revision History

Version	Date	Author	Note
-	2020-09-22	Kenny YIN	Creation of the document
1.0	2020-09-22	Kenny YIN	First official release
1.1	2021-01-12	Kenny YIN	Updated the antenna image in Chapter 2.
1.2	2021-07-01	Kenny YIN	Updated the package quantity in Chapter 8.
1.3	2021-09-28	Aria CHU	Added the new OC YC0011AAEVB on the cover.

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1 Product Description

The antenna is designed for superior performance, and can be widely used for wireless applications.

We provide comprehensive antenna design support such as simulation, testing and manufacturing for custom antenna solutions to meet your specific application needs.

2 Product Features

- Wi-Fi/Bluetooth
- High efficiency
- Excellent performance



3 Product Specifications

Passive Electrical Specifications				
Frequency Range	2400–2500 MHz, 5150–5850 MHz			
Input Impendence	50 Ω			
Return Loss	Max7 dB			
Gain	≤ 4 dBi			
Polarization Type	Linear			
Mechanical Specifications				
Antenna Size	5.0 mm × 2.0 mm × 1.0 mm			
Casing	-			
Radiator	Ceramic Patch			
Connector Type	SMD			
Working Temperature	-40 °C to +85 °C			
Radome Color	-			

4 Overall Performance

4.1. Test Environment

- KEYSIGHT VNA Network Analyzer E5063A, 100 kHz 6.5 GHz
- RayZone[®] 2800 Chamber 5G (FR1) SISO/MIMO, 400 MHz 6.0 GHz

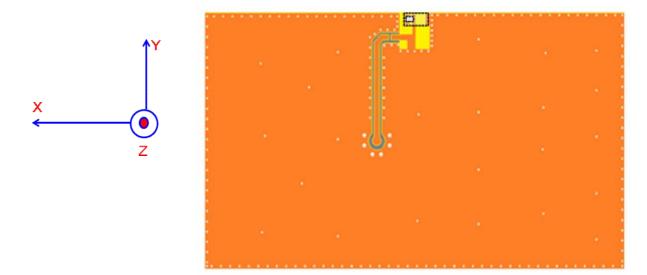


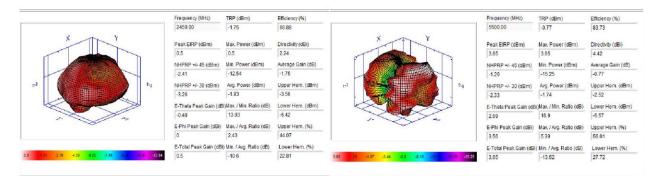
4.2. Return Loss

▶ [71] S33 Smith (R+jX) Scale 1.000U [F1 D&M]	
1 2.4180180 GHz 18.692 Ω -4.8079-Ω 13.690 pF 2 2.5180180 GHz 53.638 Ω -49.085 Ω 1.2877 pF 3 2.4500000 GHz 40.701 Ω 5.9617 Ω 387.28 pH 4 5.1500000 GHz 65.066 Ω -41.199 Ω 250111 FF 5 5.8500000 GHz 21.918 Ω 10.386 Ω 282.57 pH >6 5.5000000 GHz 35.883 Ω -9.6158 Ω 3.0093 pF	
Tr2 S33 Log Mag 10.00dB/ Ref 0.000dB [F1]	
50.00 1 2.4180180 GHz -6.7457 dB	
40.00 2 2.5180180 GHz -7.3448 dB 3 2.4500000 GHz -18.307 dB	
30.00 4 5.1500000 GHz -8.8999 dB	
5 5.8500000 GHz -7.7011 dB 20.00 >6 5.5000000 GHz -14.082 dB	
10.00	
0.000	
-10,00	e e
1/2	
-20.00	
3	
-30.00	
-30.00 -40.00	

Frequency (MHz)	2418	2518	2450	5150	5850	5500
Return Loss	-6.75	-7.34	-18.3	-8.90	-7.70	-14.1

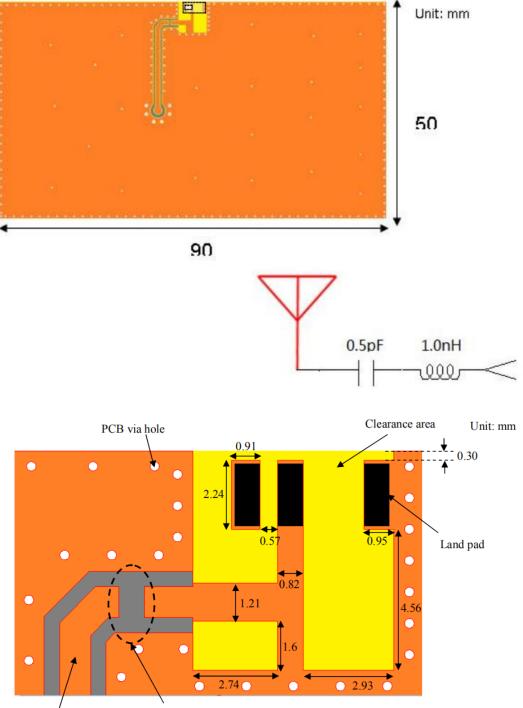
4.3. Radiation Pattern





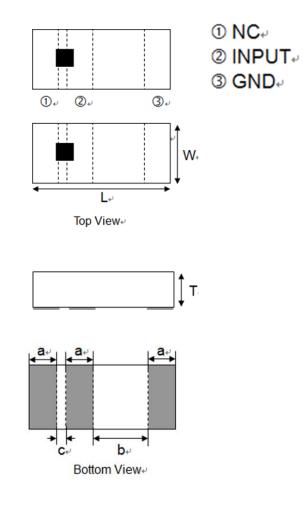
XY Plane (+ Z View)	XZ Plane (- Y View)	XZ Plane (+ Y View)	XY Plane (+ Z View)	XZ Plane (- Y View)	XZ Plane (+ Y View)
x	X	x	x	x	x
	и	z		H	Z
XY Plane (- Z View)	YZ Plane (+ X View)	YZ Plane (- X View)	XY Plane (- Z View)	YZ Plane (+ X View)	YZ Plane (- X View)
.	M			Y Ed	N Y

4.4. Reference PCB Design (Unit: mm)



50 ohms feeding line T type matching circuit

5 Product Size (mm)



Symbol	L	W	Т	а	b	С
Dimensions	5.00 ±0.20	2.0 ±0.20	1.0 ±0.2	0.8 ±0.1	2.0 ±0.2	0.6 ±0.2

6 Reliability Test

Temperature Range	25 ±5 °C
Relative Humidity Range	55–75 %
Operating Temperature Range	-40 °C to +85 °C
Storage Temperature Range	-40 °C to +85 °C

6.1. Vibration Resistance

The device should fulfil the electrical specification after being applied to the vibration of 10–55 Hz with amplitude of 1.5 mm for 2 hours in X, Y and Z directions respectively.

6.2. Drop and Shock Tests

The device should have no mechanical damage after dropping onto the hard wooden board from the height of 100 cm for 3 times at each facet of the 3 dimensions of the device.

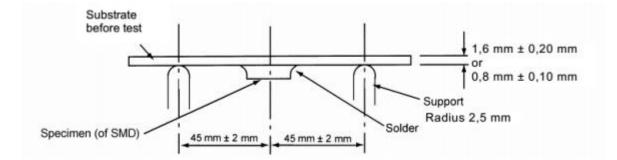
6.3. Resistance to Soldering Heat

The device should have no damage after pre-heating at 120–150 °C for 120 seconds and immersion in Sn solder at 255 \pm 10 °C for 5 \pm 0.5 seconds, or electric iron at 300 \pm 10 °C for 3 \pm 0.5 seconds.

6.4. Adhesive Strength of Termination

The device should have no remarkable damage or removal of the termination after horizontal force of 5 N (\leq 0603); 10 N (> 0603) for 10 ±1 seconds.

6.5. Bending Resistance Test



Weld the product to the central part of the PCB with the thickness 1.6 ± 0.2 mm or 0.8 ± 0.1 mm as the illustration shows, and keep exerting force arrow-ward on it at speed of 1 mm/s, and hold for 5 ± 1 seconds at the position of 1.5 mm bending distance, so far, any peeling-off of the product metal coating should not be detected.

6.6. Moisture Proof

The device should fulfil the electrical specification after being exposed to the temperature 60 \pm 2 °C and the relative humidity 90–95 % for 96 hours and experiencing 1–2 hours recovery time under normal condition.

6.7. High Temperature Endurance

The device should fulfil the electrical specification after being exposed to temperature 85 \pm 5 °C for 96 \pm 2 hours and experiencing 1–2 hours recovery time under normal temperature.

6.8. Low Temperature Endurance

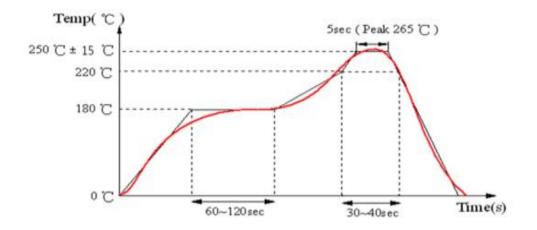
The device should fulfil the electrical specification after being exposed to the temperature -40 \pm 5 °C for 96 \pm 2 hours and experiencing 2 hours recovery time under normal temperature.

6.9. Temperature Cycle Test

The device should fulfil the electrical specification after being exposed to the low temperature -40 °C and high temperature +85 °C for 30 \pm 2 minutes each by 5 cycles and experiencing 1 to 2 hours recovery time under normal temperature.

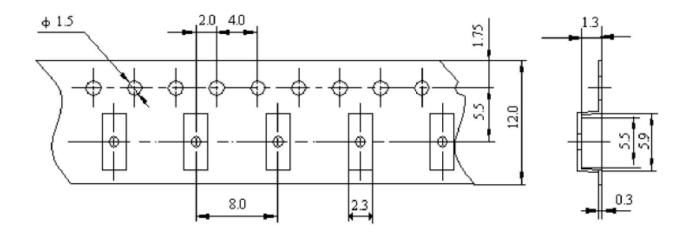


7 Reflow Soldering Standard Condition



8 Packaging and Dimensions

8.1. Plastic Tape



Packaging Note:

Reserve 150–200 mm of space at the trailing end of the carrier, 250–300 mm of space at the front end of the carrier and a further 250 mm space of cover tape at the front end of the carrier.

8.2. Reel (3000 pcs/reel)

